

TOSHIBA Zener Diode Silicon Epitaxial Planar Type

CSLZ Series

1. Applications

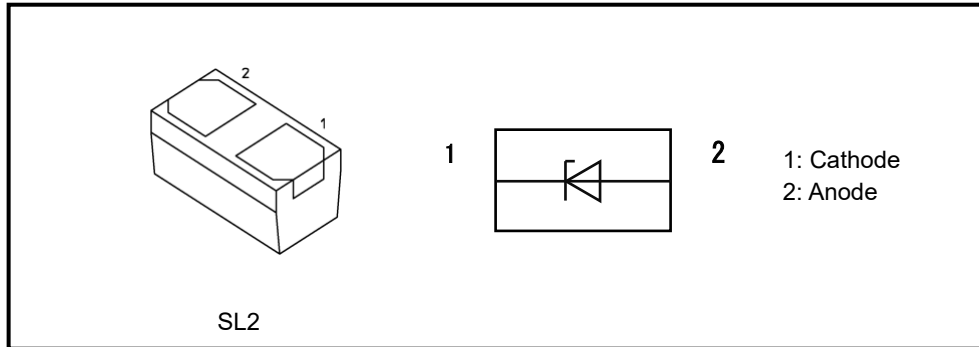
Voltage surge protection

2. Features

Small package

The typical voltage of VZ is accorded to E24 series.

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings 1 (Note) (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Power dissipation	P_D ^{Note1}	150	mW
	P_D ^{Note2}	400	mW
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 to 150	°C

5. Absolute Maximum Ratings 2 (Note) (Unless otherwise specified, Ta = 25°C)

Type No.	Electrostatic discharge Voltage ^{Note3}		Peak pulse power ^{Note4}	Peak pulse current ^{Note4}	Type No.	Electrostatic discharge Voltage ^{Note3}		Peak pulse power ^{Note4}	Peak pulse current ^{Note4}
	Contact	Air				Contact	Air		
	VESD(kV)		P _{PK} (W)	I _{PP} (A)		VESD(kV)		P _{PK} (W)	I _{PP} (A)
CSLZ5V6	± 30		32	2.5	CSLZ12V	± 20		72	2.5
CSLZ6V2	± 30		37	2.5	CSLZ16V	± 12		87	2.5
CSLZ6V8	± 30		40	2.5	CSLZ20V	± 12		105	2.5
CSLZ8V2	± 30		55	2.5	CSLZ24V	± 10		117	2.5
CSLZ10V	± 30		60	2.5	CSLZ30V	± 8		145	2.5

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note1: Mounted on a glass epoxy circuit board of 20 mm × 20 mm, pad dimensions of 4 mm × 4 mm.

Note 2: Mounted on a glass epoxy circuit board of 25.4 mm × 25.4 mm × 1.6 mmt, Cu pad: 645 mm²

Note 3: according to IEC61000-4-2

Note 4: according to IEC61000-4-5, tp = 8 / 20 μs

Start of commercial production
2022-04

6. Electrical Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

Type No.	Zener Voltage			Test Current I_z (mA)	Dynamic Impedance		Dynamic resistance R_{DYN} (Ω) Note1	Clamp voltage V_C (V) Note1, Note2	Total capacitance C_t (pF) Note3	Reverse Current	
	V_Z (V)				Z_Z (Ω)	Test Current I_z (mA)				I_R (μA)	Test Voltage V_R (V)
	Min	Typ.	Max	Max							
CSLZ5V6	5.3	5.6	6.0	5	30	5	0.25	9	35	1.0	3.5
CSLZ6V2	5.8	6.2	6.6	5	30	5	0.38	10.5	30	2.5	5.0
CSLZ6V8	6.4	6.8	7.2	5	30	5	0.5	14.5	25	0.5	5.0
CSLZ8V2	7.7	8.2	8.7	5	30	5	0.62	17	18	0.5	6.5
CSLZ10V	9.4	10	10.6	5	30	5	0.5	18	16	0.5	8.0
CSLZ12V	11.4	12	12.6	5	30	5	1.5	28	13	0.5	9
CSLZ16V	15.3	16	17.1	5	35	5	1.7	30	10.5	0.5	12
CSLZ20V	18.8	20	21.2	5	50	5	2.5	30	9.5	0.5	15
CSLZ24V	22.8	24	25.6	5	70	5	1.5	34	8.5	0.5	19
CSLZ30V	28	30	31.5	2	150	2	4	51	7.5	0.5	23

Note1: TLP parameters: $Z_0 = 50\ \Omega$, $t_p = 100\ \text{ns}$, $t_r = 300\ \text{ps}$, averaging window: $t_1 = 30\ \text{ns}$ to $t_2 = 60\ \text{ns}$,

extraction of dynamic resistance using least squares fit of TLP characteristics between $I_{TLP1} = 8\ \text{A}$ and $I_{TLP2} = 16\ \text{A}$.

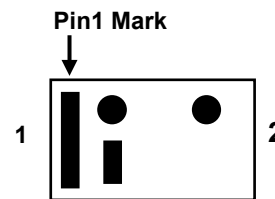
Note2: $I_{TLP} = 8\ \text{A}$

Note3: $V_R = 0\ \text{V}$, $f = 1\ \text{MHz}$

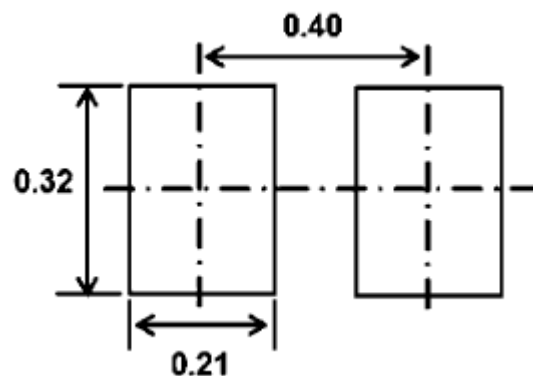
7. Marking List

Type No.	Marking	Type No.	Marking
CSLZ5V6		CSLZ12V	
CSLZ6V2		CSLZ16V	
CSLZ6V8		CSLZ20V	
CSLZ8V2		CSLZ24V	
CSLZ10V		CSLZ30V	

8. Marking (CSLZ5V6)

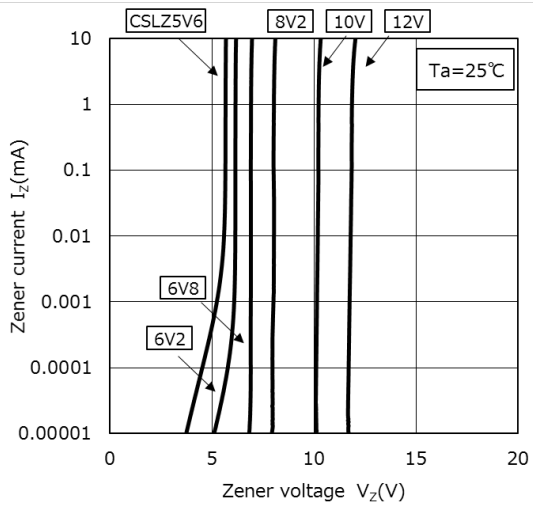


9. Land Pattern Dimensions (for reference only) (Unit: mm)

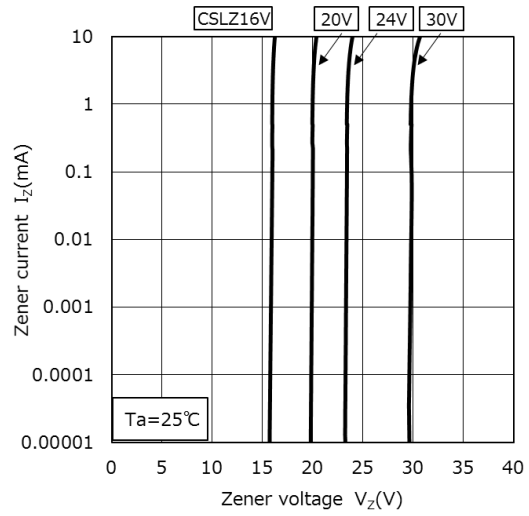


10. Characteristics Curves

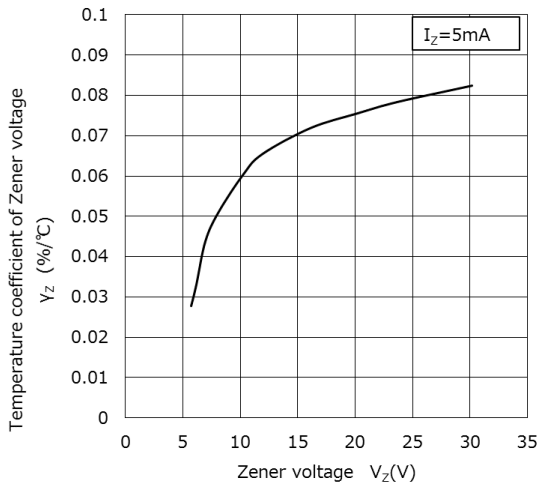
10.1. CSLZ series Characteristics Curves (Note)



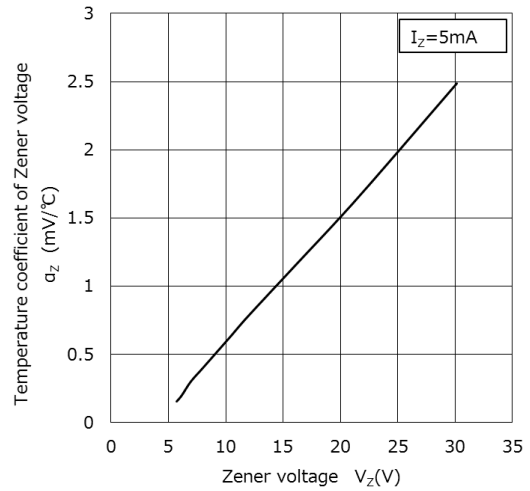
$I_z - V_z$ (1)



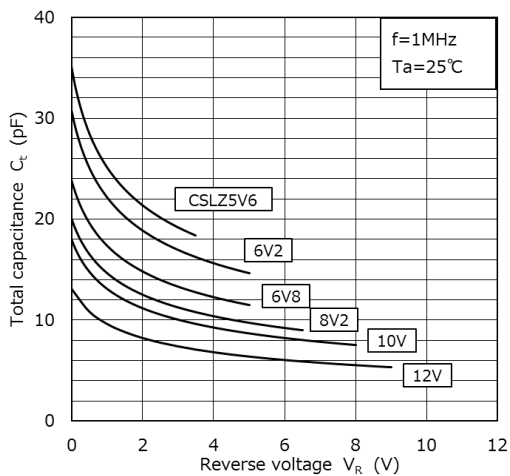
$I_z - V_z$ (2)



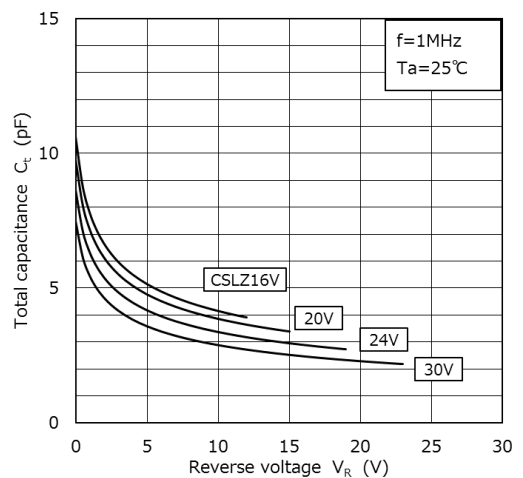
$Y_z - V_z$



$\alpha_z - V_z$

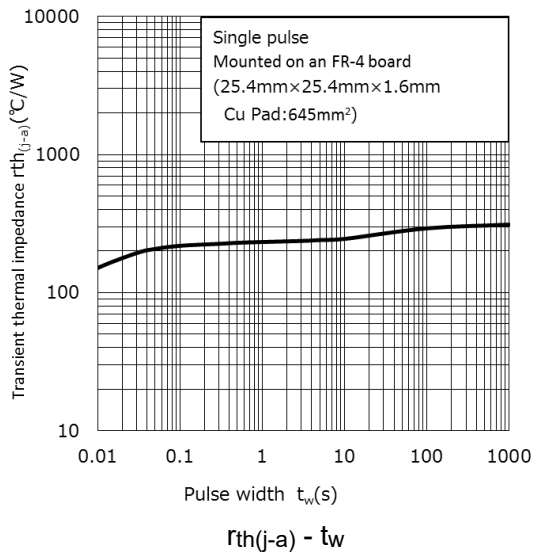
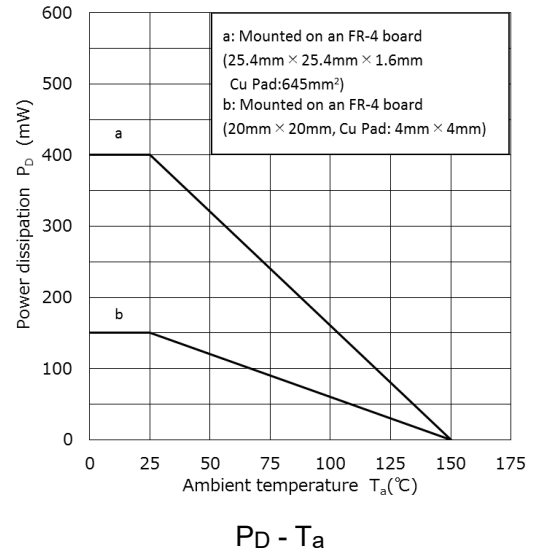
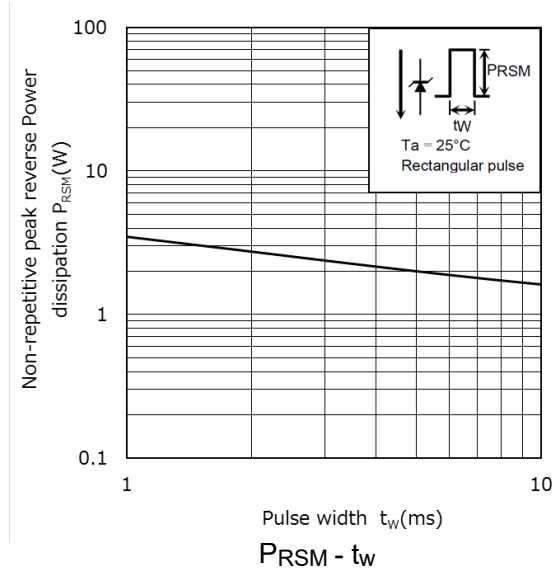


$C_t - V_R$ (1)



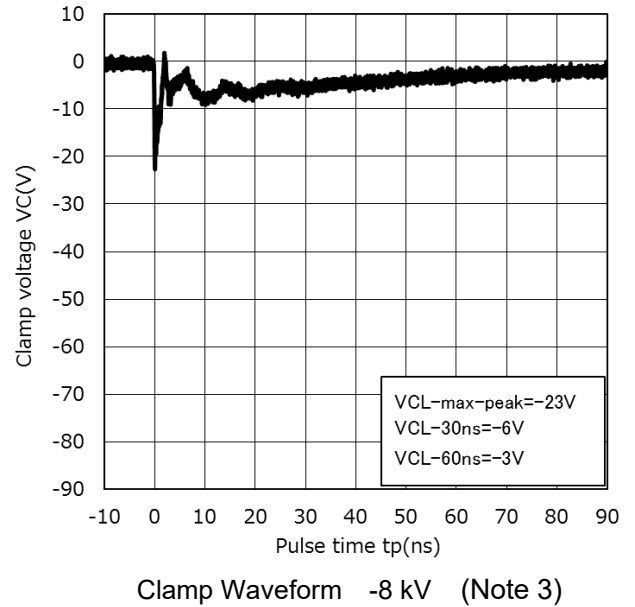
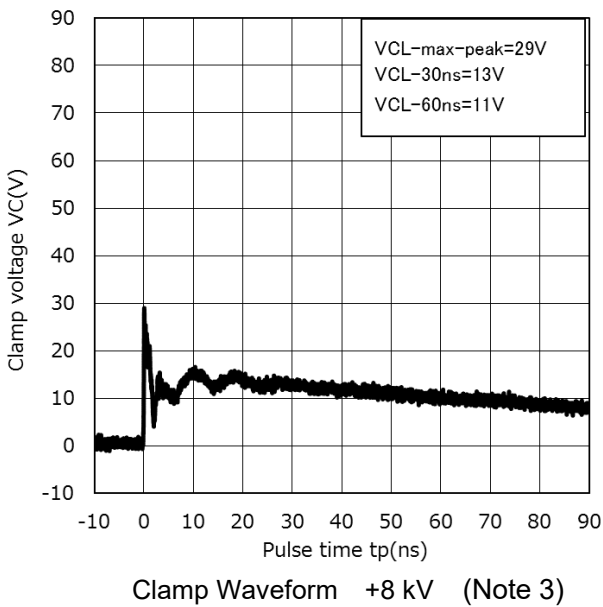
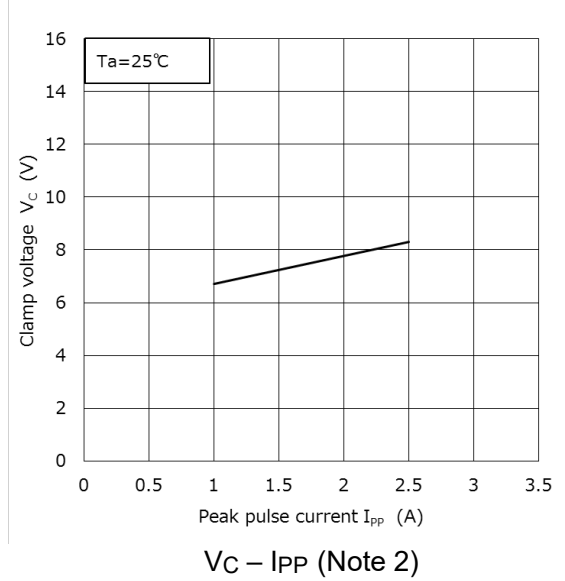
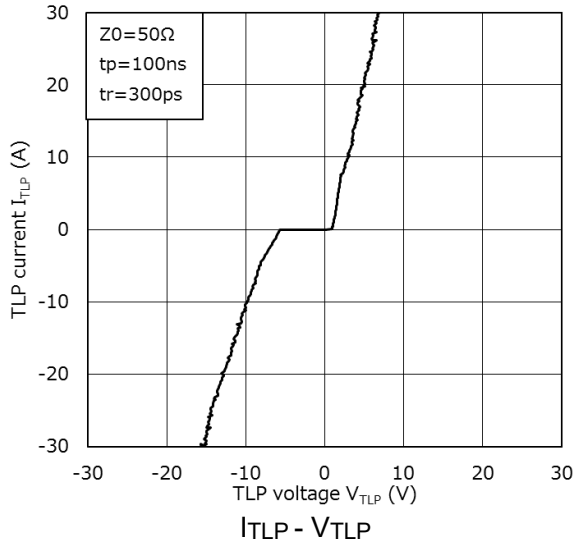
$C_t - V_R$ (2)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

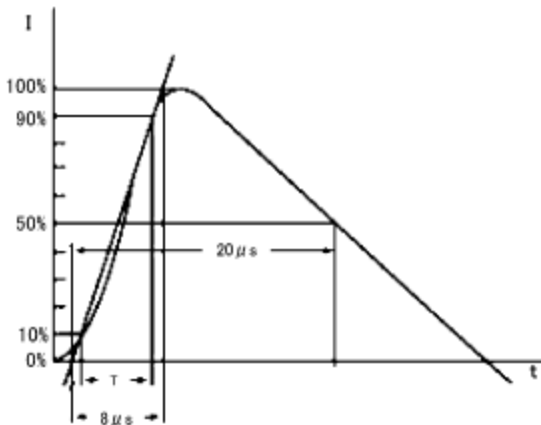


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

10.2. CSLZ5V6 Characteristics Curves (Note1)

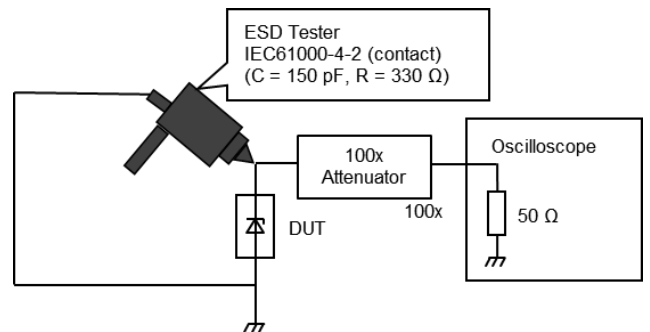


(Note 2) Peak Pulse Current ($V_c - I_{pp}$)



Based on IEC61000-4-5 8/20 μs pulse..

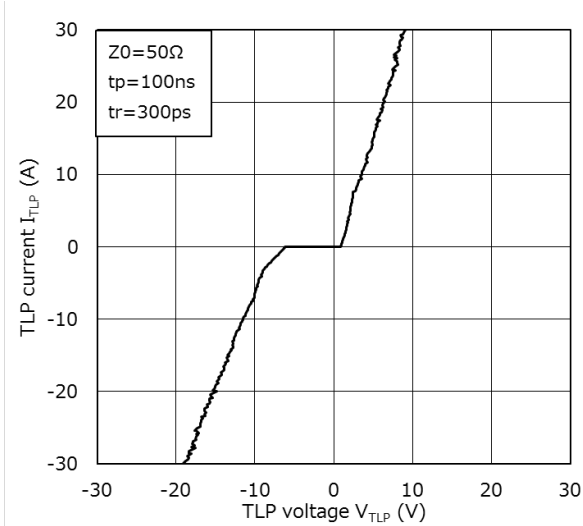
(Note 3) Clamp waveform measurement circuit



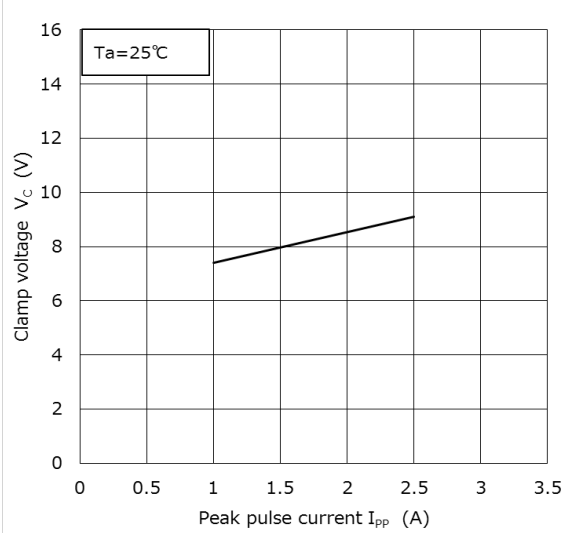
Based on IEC61000-4-2 (Contact)

Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

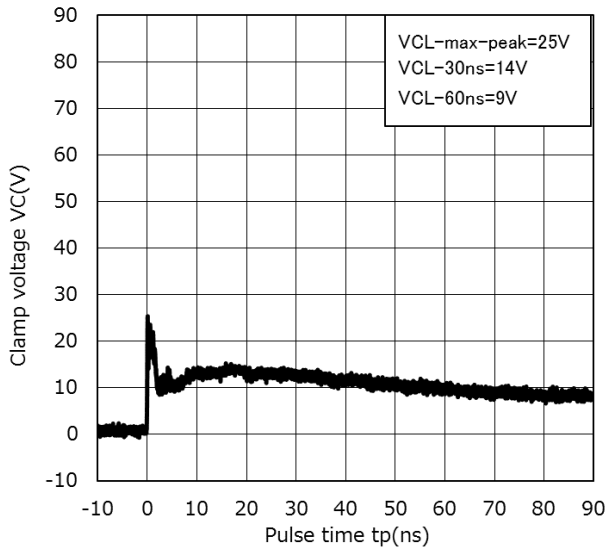
10.3. CSLZ6V2 Characteristics Curves (Note 1)



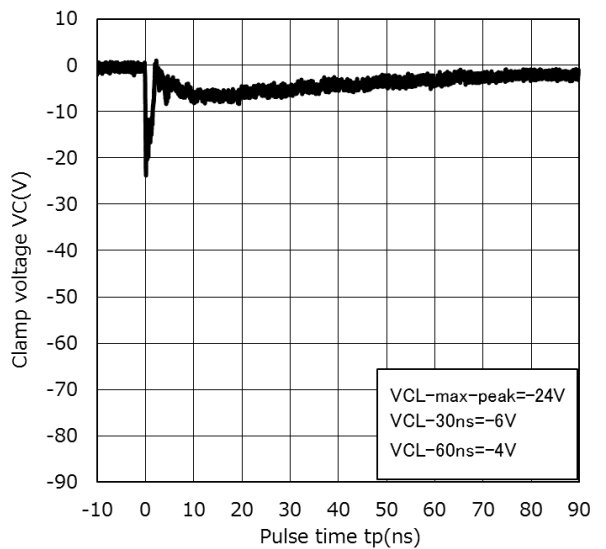
$I_{TLP} - V_{TLP}$



$V_C - I_{PP}$ (Note 2)

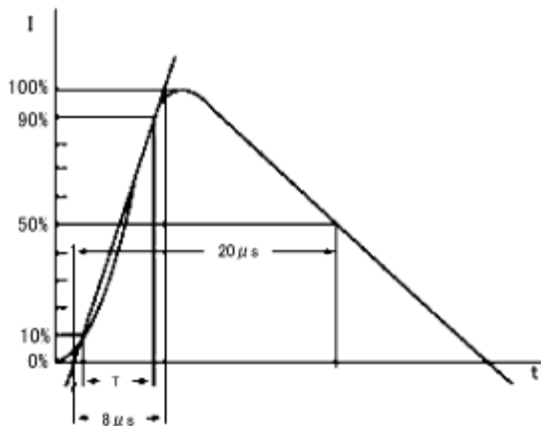


Clamp Waveform +8 kV (Note 3)



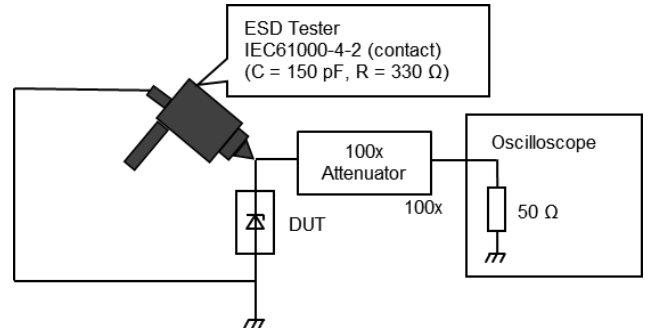
Clamp Waveform -8 kV (Note 3)

(Note 2) Peak Pulse Current ($V_C - I_{PP}$)



Based on IEC61000-4-5 8/20 μ s pulse.

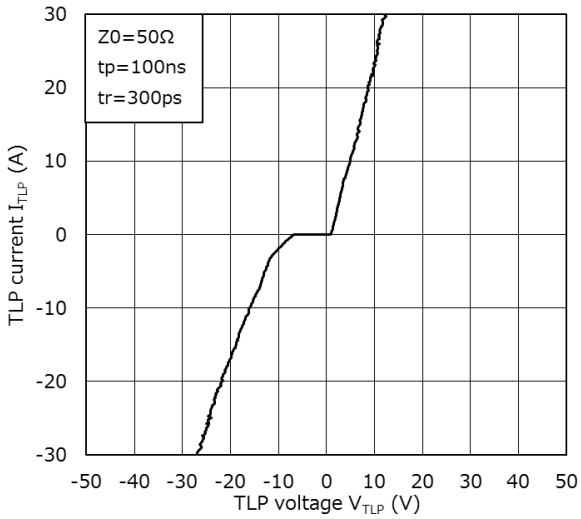
(Note 3) Clamp waveform measurement circuit



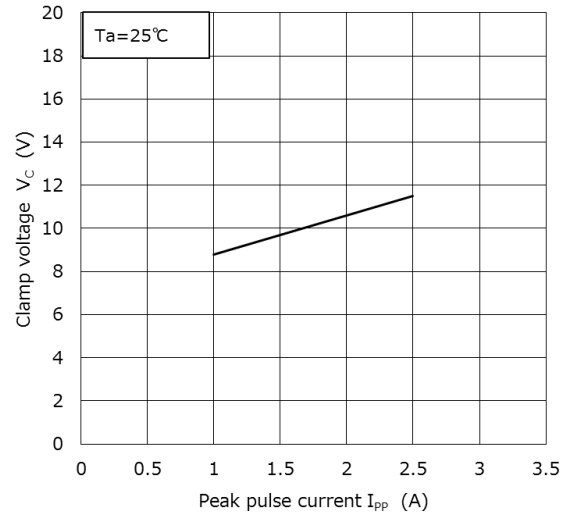
Based on IEC61000-4-2 (Contact)

Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

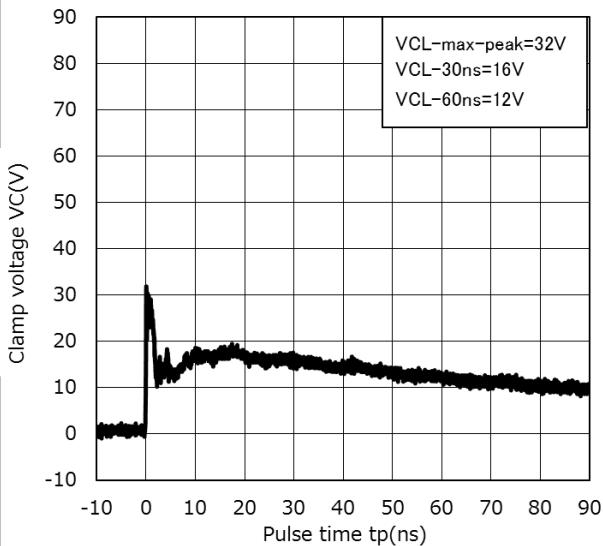
10.4. CSLZ6V8 Characteristics Curves (Note 1)



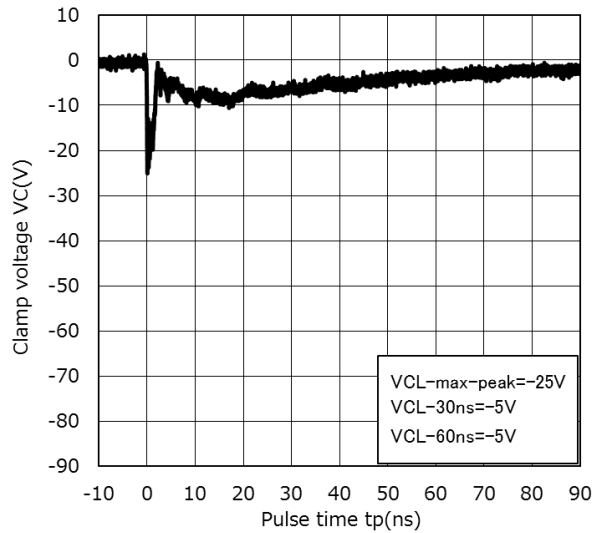
$I_{TLP} - V_{TLP}$



$V_C - I_{PP}$ (Note 2)

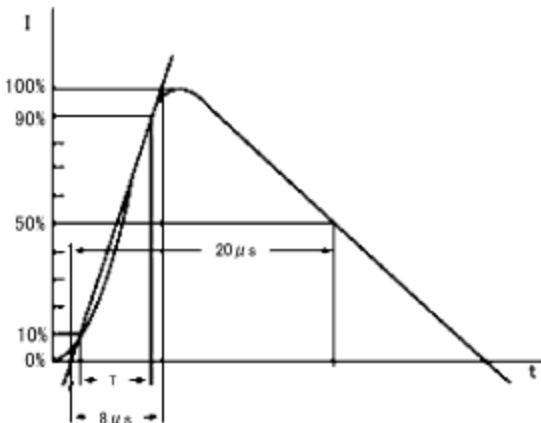


Clamp Waveform +8 kV (Note 3)



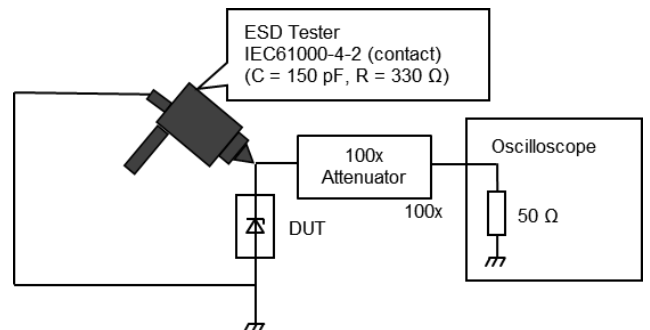
Clamp Waveform -8 kV (Note 3)

(Note 2) Peak Pulse Current ($V_C - I_{PP}$)



Based on IEC61000-4-5 8/20 μs pulse.

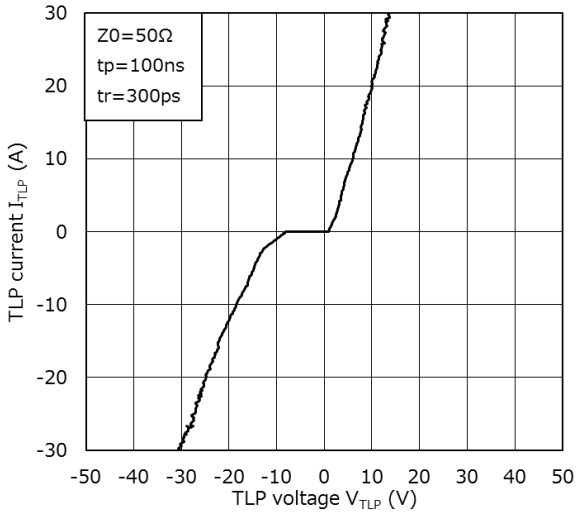
(Note 3) Clamp waveform measurement circuit



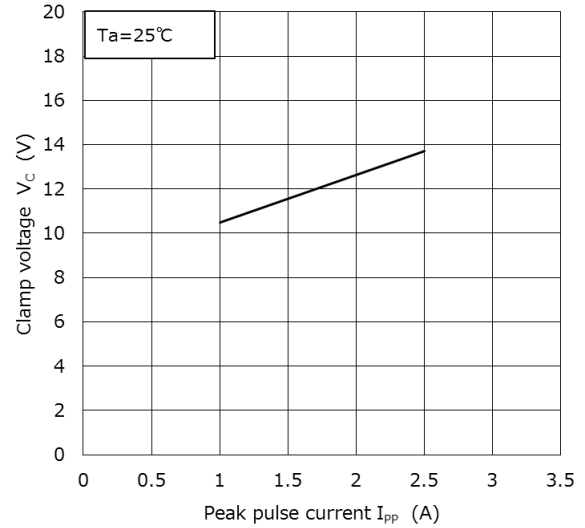
Based on IEC61000-4-2 (Contact)

Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

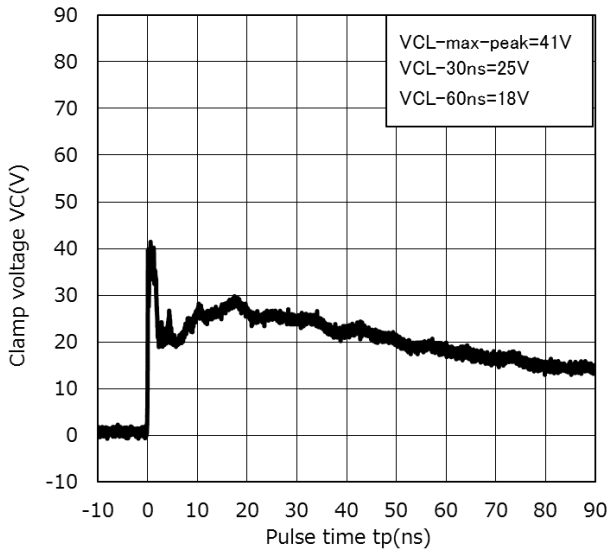
10.5. CSLZ8V2 Characteristics Curves (Note 1)



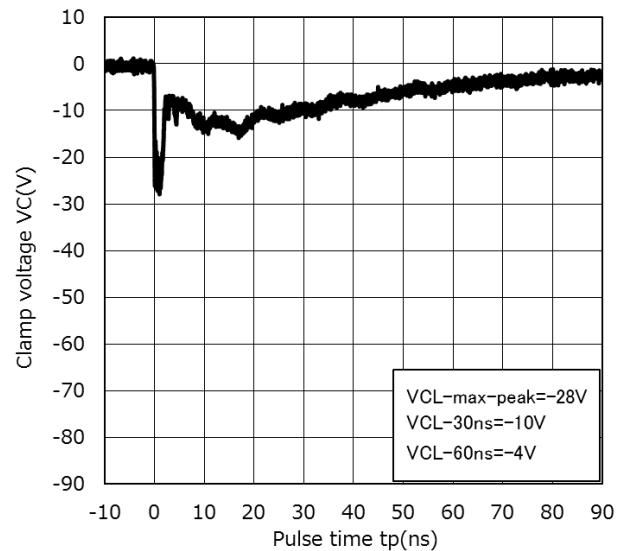
$I_{TLP} - V_{TLP}$



$V_C - I_{PP}$ (Note 2)

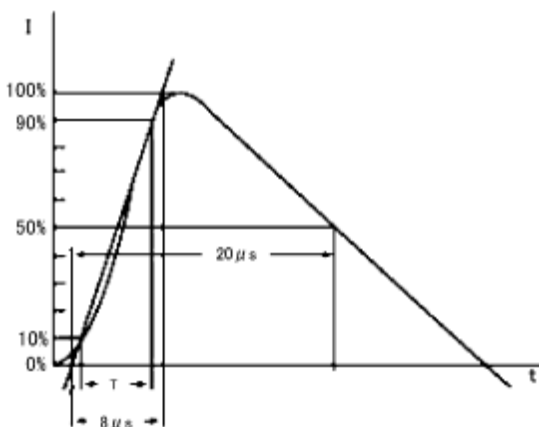


Clamp Waveform +8 kV (Note 3)



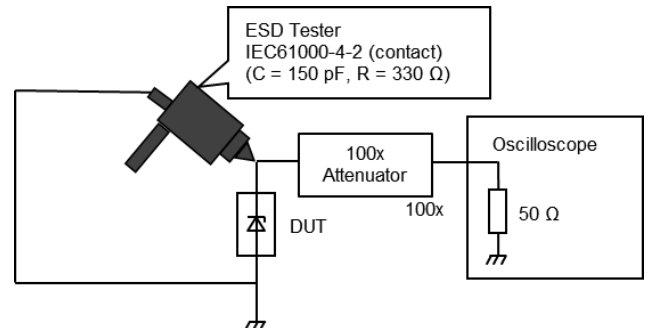
Clamp Waveform -8 kV (Note 3)

(Note 2) Peak Pulse Current ($V_C - I_{PP}$)



Based on IEC61000-4-5 8/20 μs pulse.

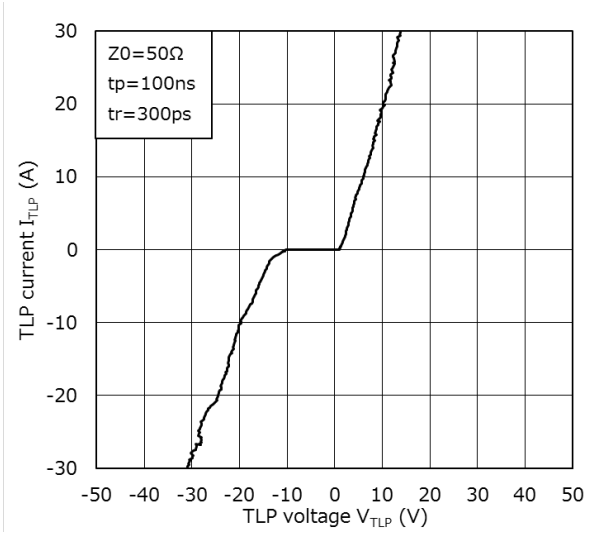
(Note 3) Clamp waveform measurement circuit



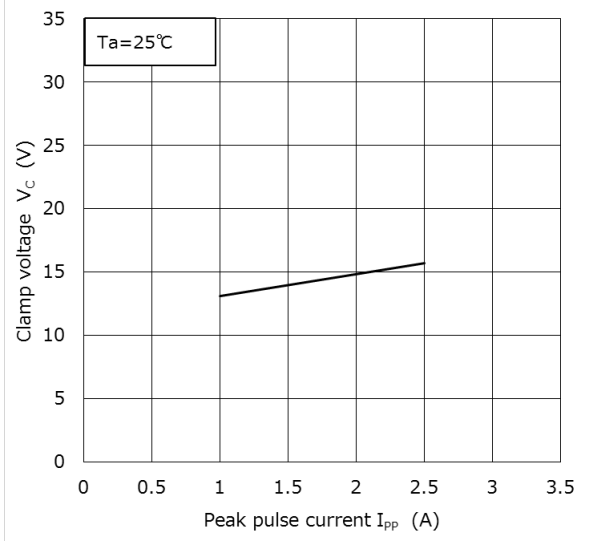
Based on IEC61000-4-2 (Contact)

Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

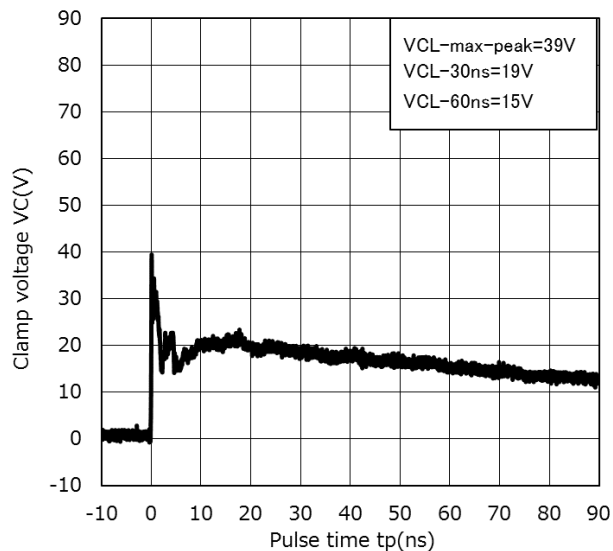
10.6. CSLZ10V Characteristics Curves (Note 1)



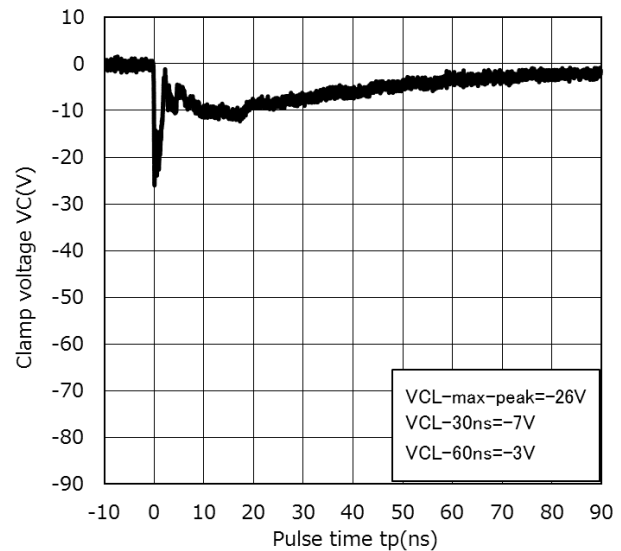
$I_{TLP} - V_{TLP}$



$V_C - I_{pp}$ (Note 2)

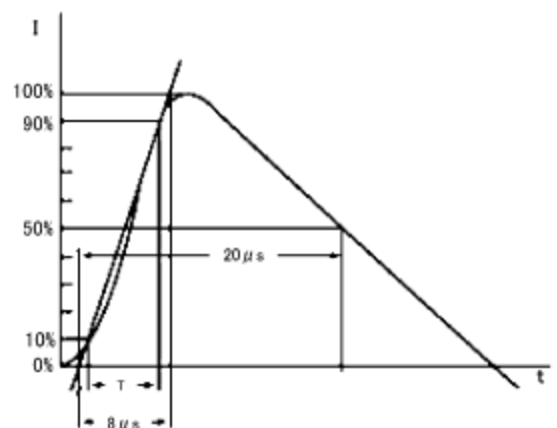


Clamp Waveform +8 kV (Note 3)



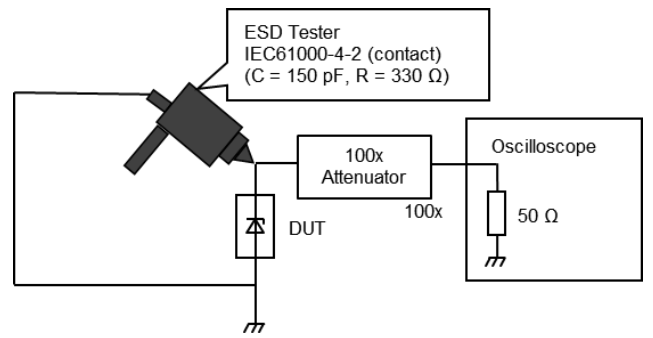
Clamp Waveform -8 kV (Note 3)

(Note 2) Peak Pulse Current ($V_C - I_{pp}$)



Based on IEC61000-4-5 8/20 μs pulse.

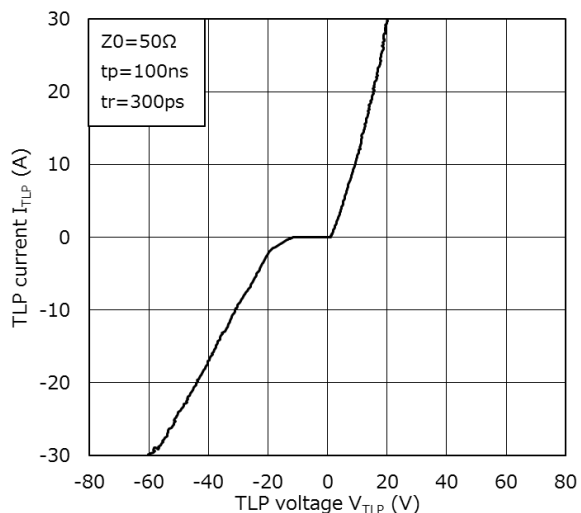
(Note 3) Clamp waveform measurement circuit



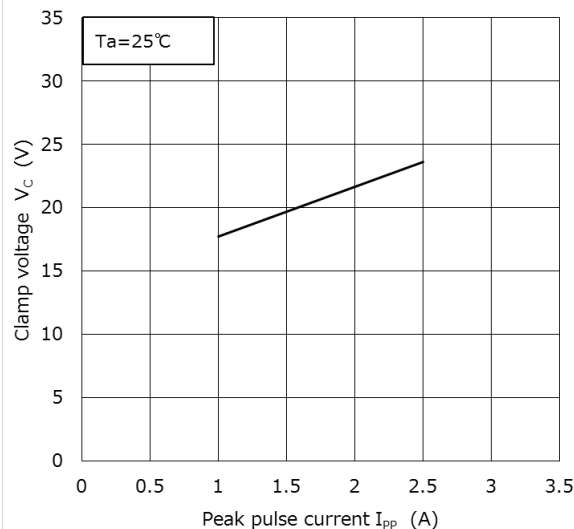
Based on IEC61000-4-2 (Contact)

Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

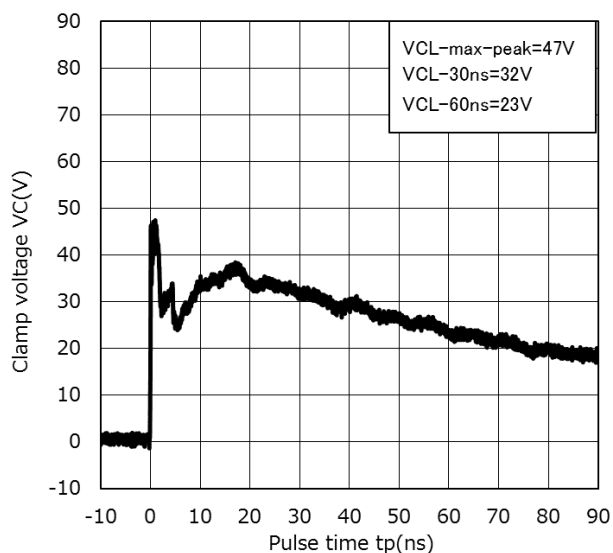
10.7. CSLZ12V Characteristics Curves (Note 1)



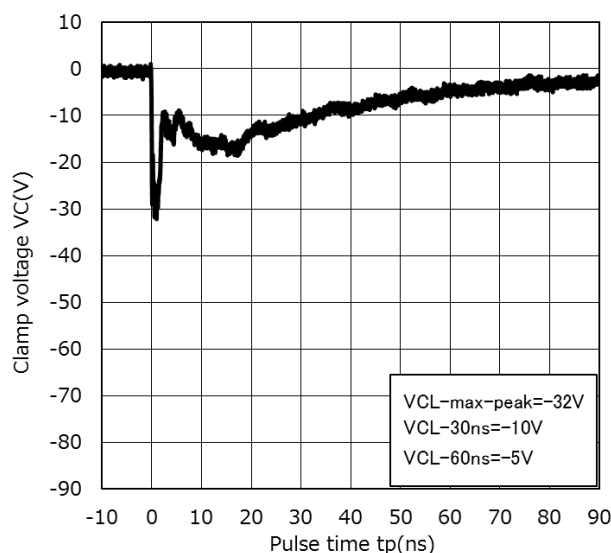
$I_{TLP} - V_{TLP}$



$V_C - I_{PP}$ (Note 2)

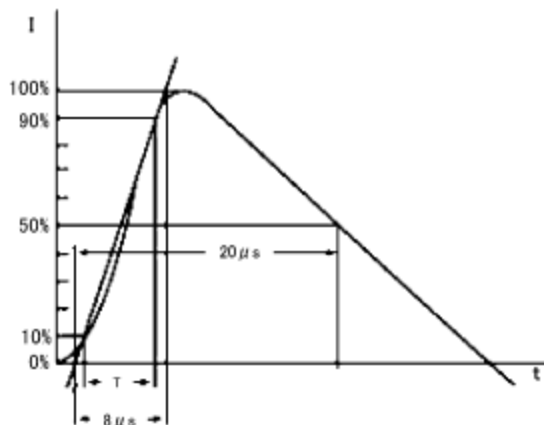


Clamp Waveform +8 kV (Note 3)



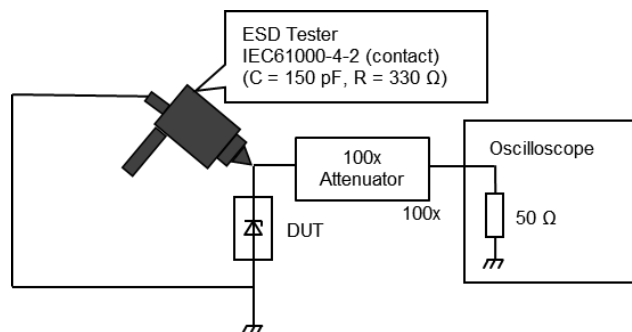
Clamp Waveform -8 kV (Note 3)

(Note 2) Peak Pulse Current ($V_C - I_{PP}$)



Based on IEC61000-4-5 8/20 μ s pulse.

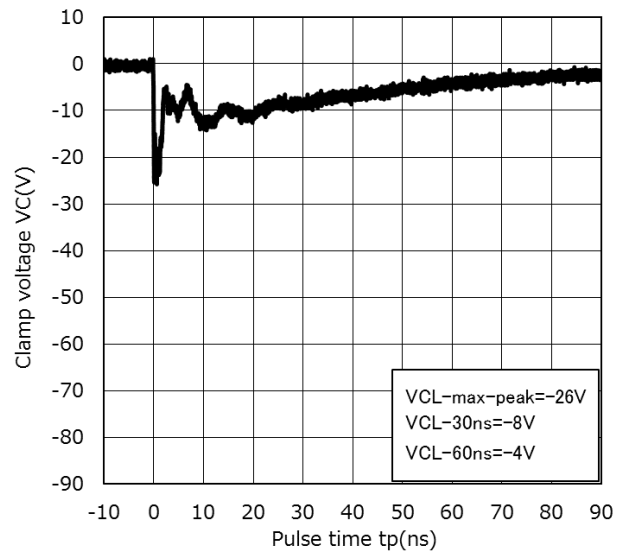
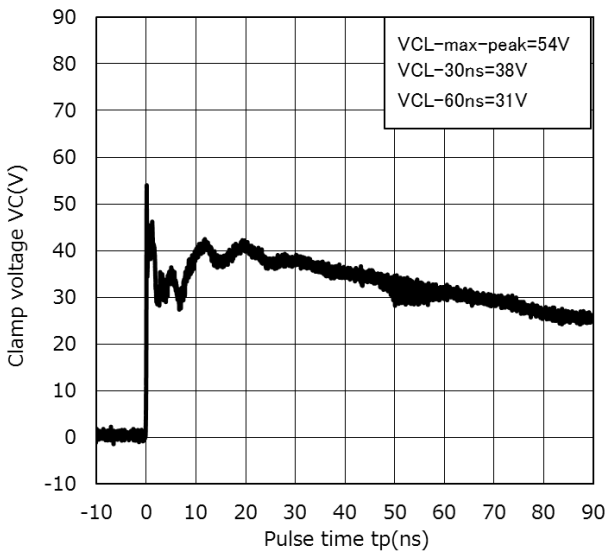
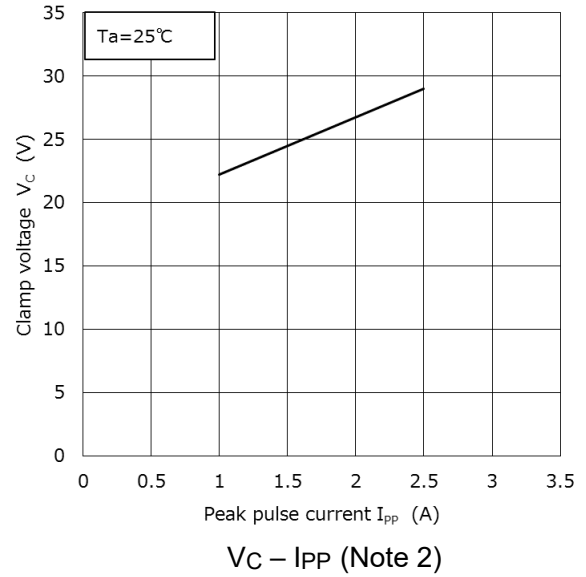
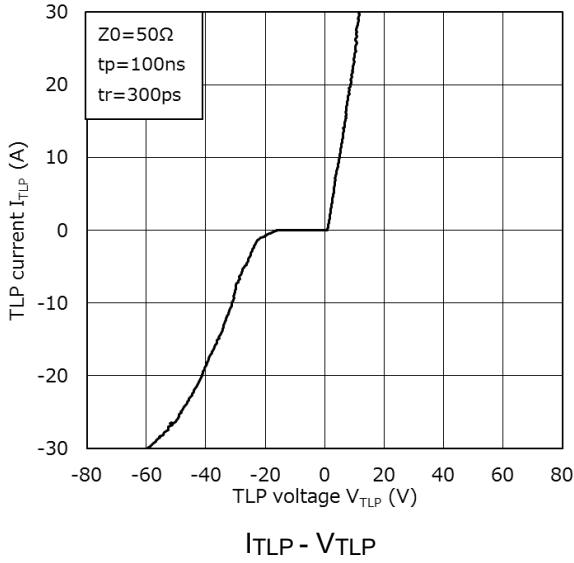
(Note 3) Clamp waveform measurement circuit



Based on IEC61000-4-2 (Contact)

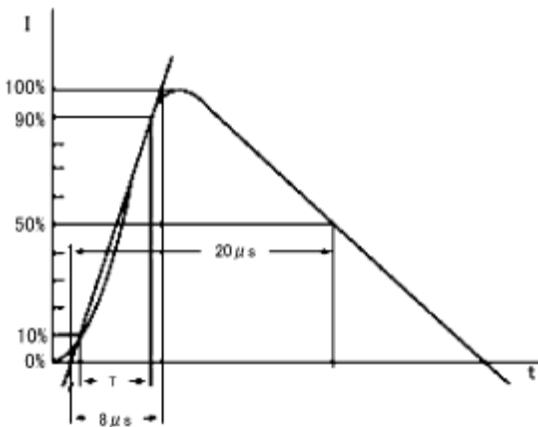
Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

10.8. CSLZ16V Characteristics Curves (Note 1)

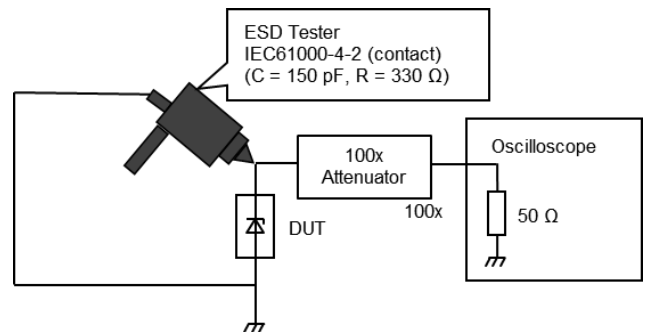


(Note 2) Peak Pulse Current ($V_C - I_{PP}$)

(Note 3) Clamp waveform measurement circuit



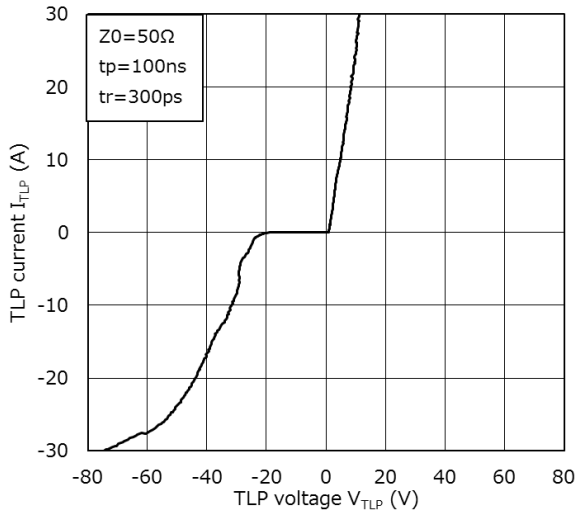
Based on IEC61000-4-5 8/20 μs pulse.



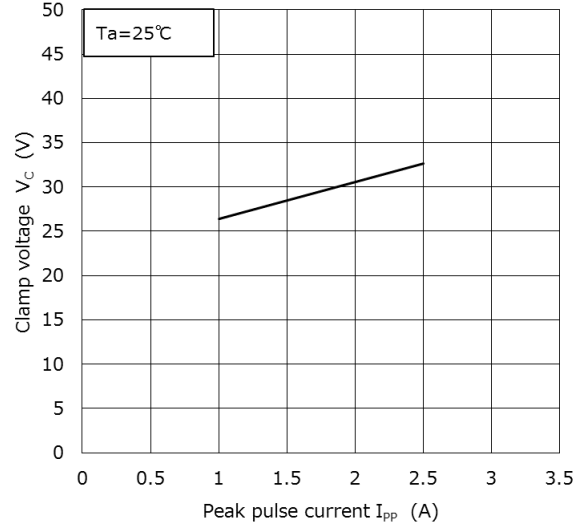
Based on IEC61000-4-2 (Contact)

Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

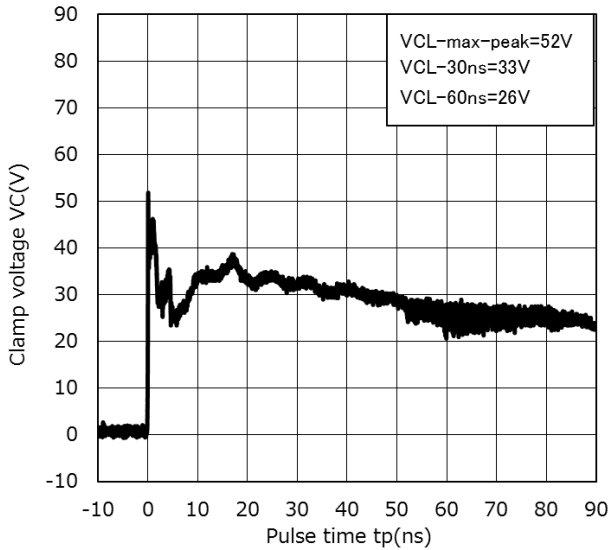
10.9. CSLZ20V Characteristics Curves (Note 1)



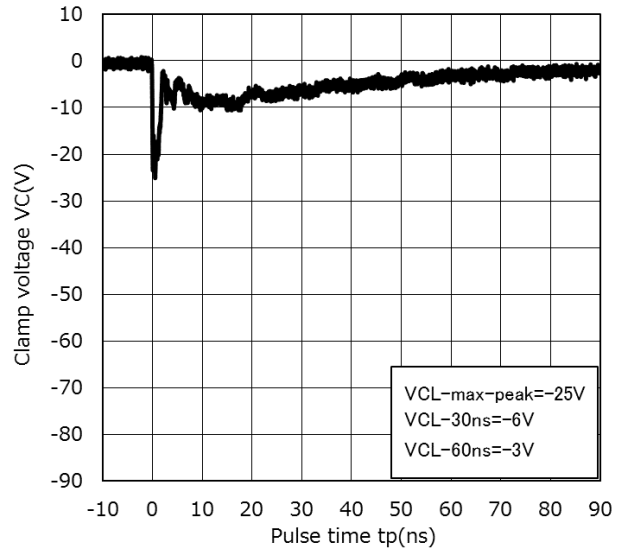
$I_{TLP} - V_{TLP}$



$V_C - I_{PP}$ (Note 2)

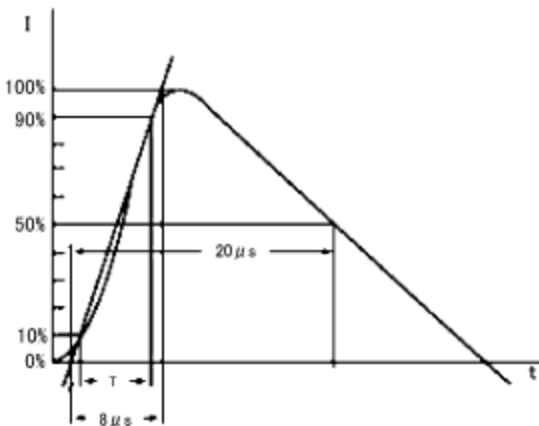


Clamp Waveform +8 kV (Note 3)



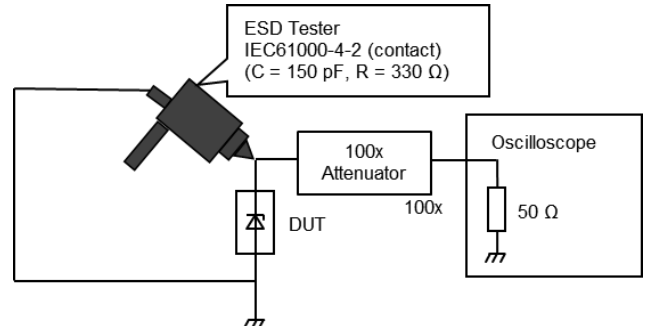
Clamp Waveform -8 kV (Note 3)

(Note 2) Peak Pulse Current ($V_C - I_{PP}$)



Based on IEC61000-4-5 8/20 μs pulse.

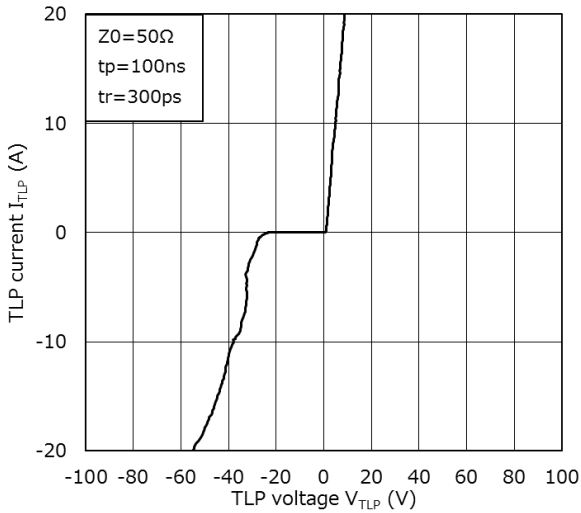
(Note 3) Clamp waveform measurement circuit



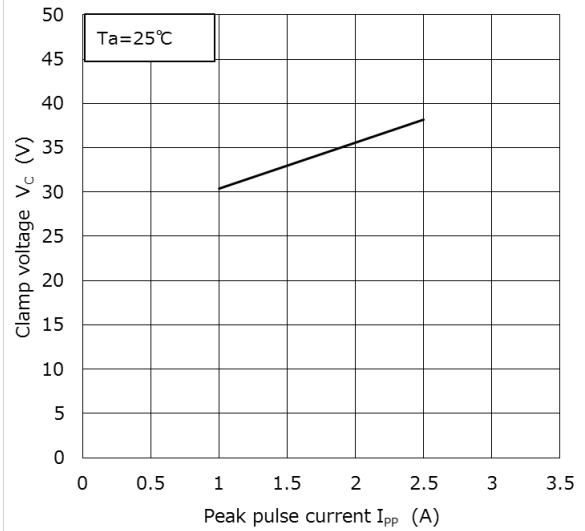
Based on IEC61000-4-2 (Contact)

Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

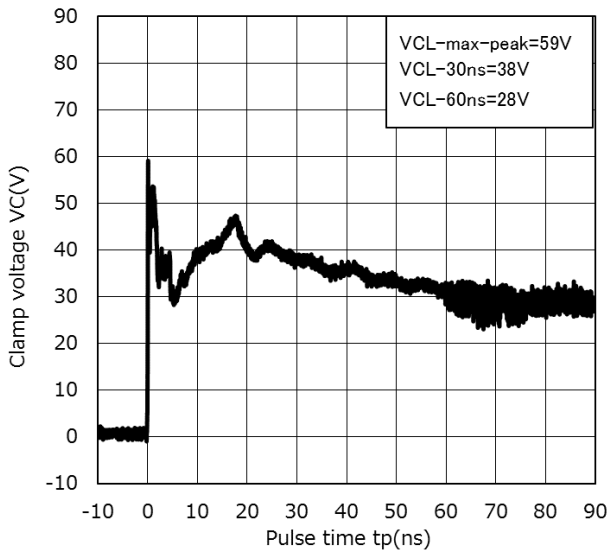
10.10. CSLZ24V Characteristics Curves (Note 1)



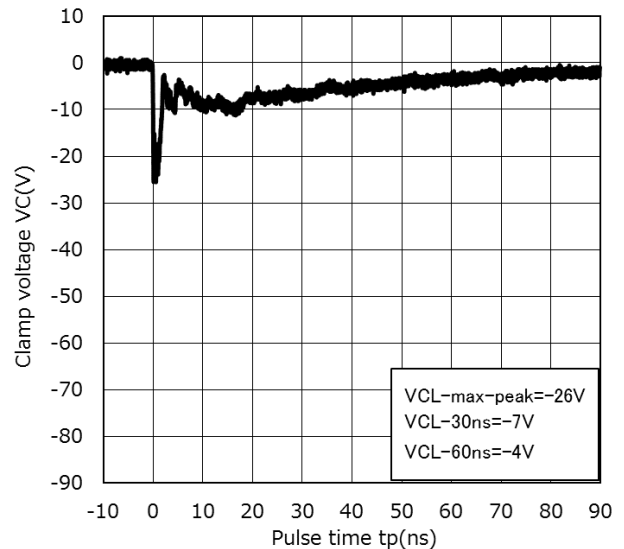
$I_{TLP} - V_{TLP}$



$V_C - I_{PP}$ (Note 2)

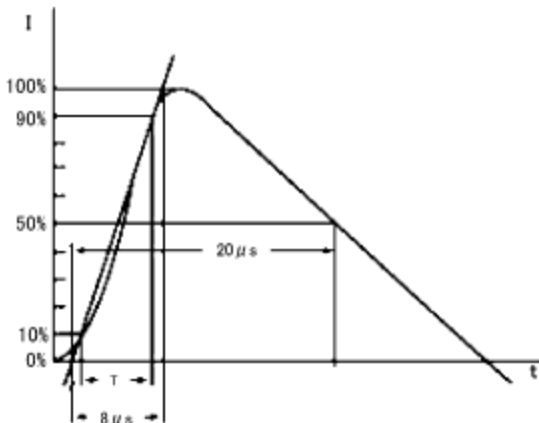


Clamp Waveform +8 kV (Note 3)



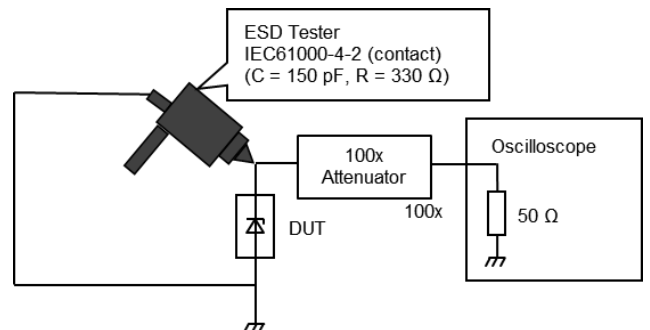
Clamp Waveform -8 kV (Note 3)

(Note 2) Peak Pulse Current ($V_C - I_{PP}$)



Based on IEC61000-4-5 8/20 μ s pulse.

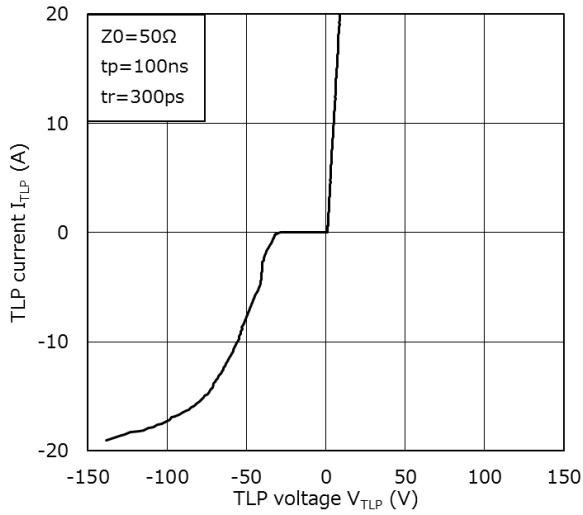
(Note 3) Clamp waveform measurement circuit



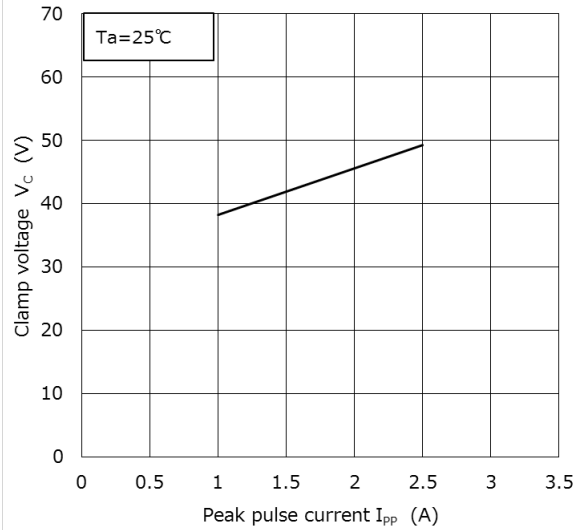
Based on IEC61000-4-2 (Contact)

Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

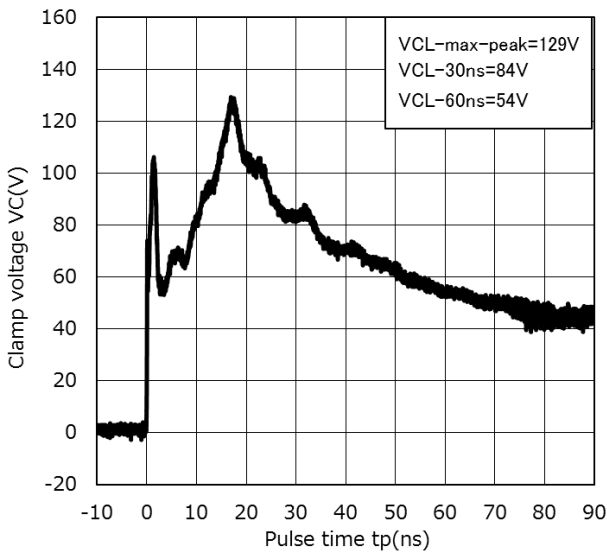
10.11. CSLZ30V Characteristics Curves (Note 1)



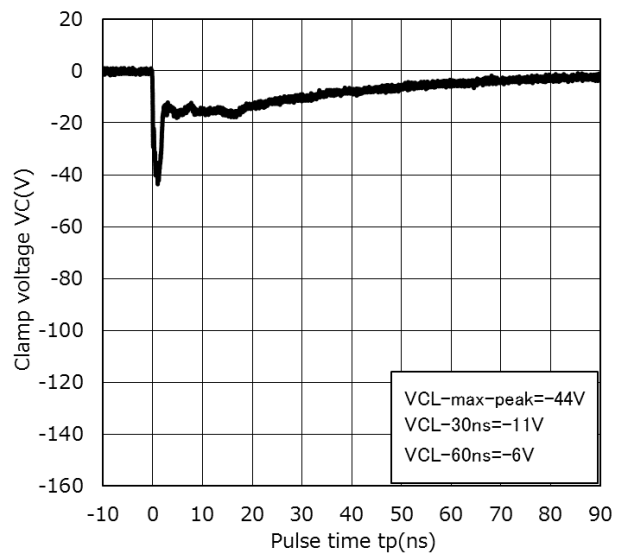
$I_{TLP} - V_{TLP}$



$V_C - I_{PP}$ (Note 2)

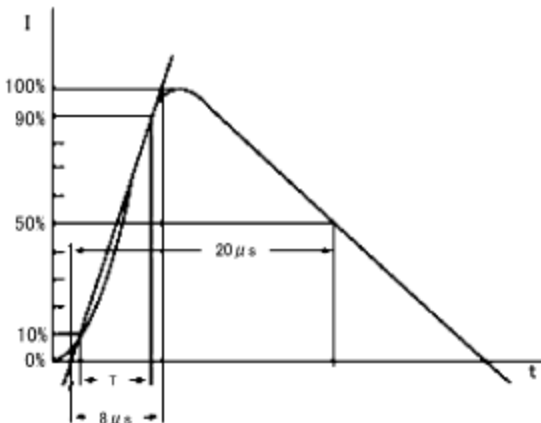


Clamp Waveform +8 kV (Note 3)



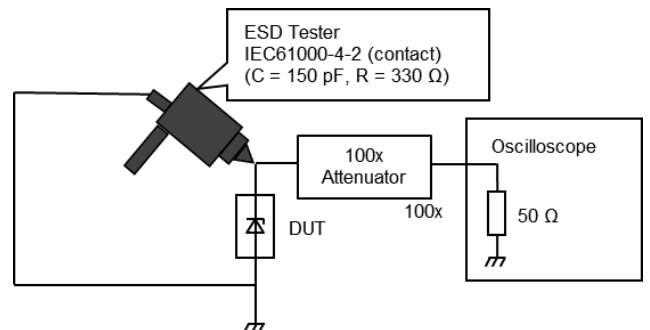
Clamp Waveform -8 kV (Note 3)

(Note 2) Waveform example ($V_C - I_{PP}$)



Based on IEC61000-4-5 8/20 μs pulse.

(Note 3) Clamp waveform measurement circuit

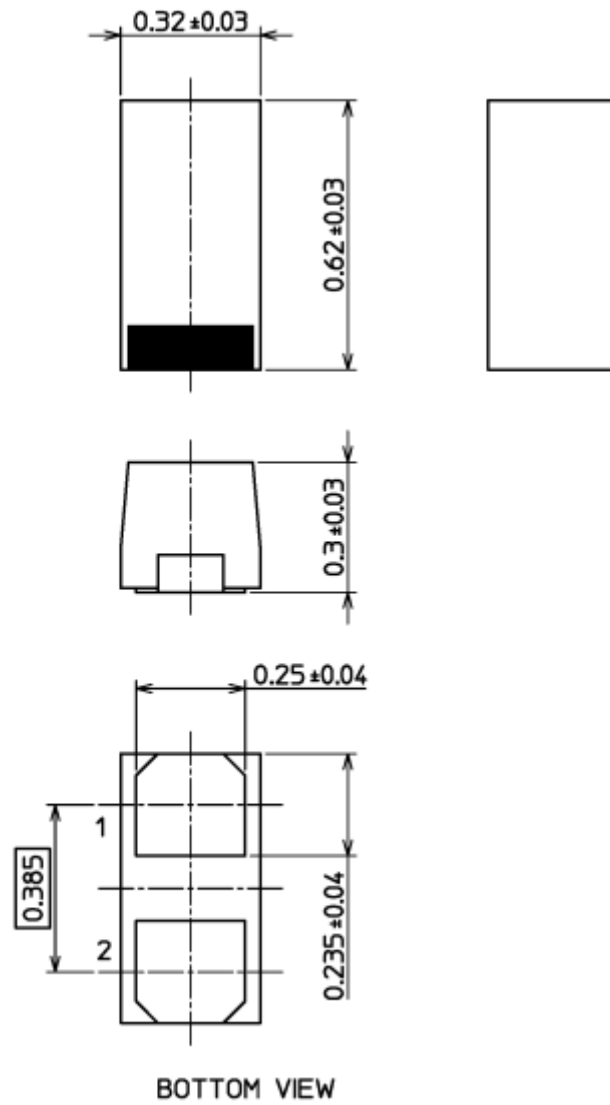


Based on IEC61000-4-2 (Contact)

Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 0.2 mg (typ.)

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